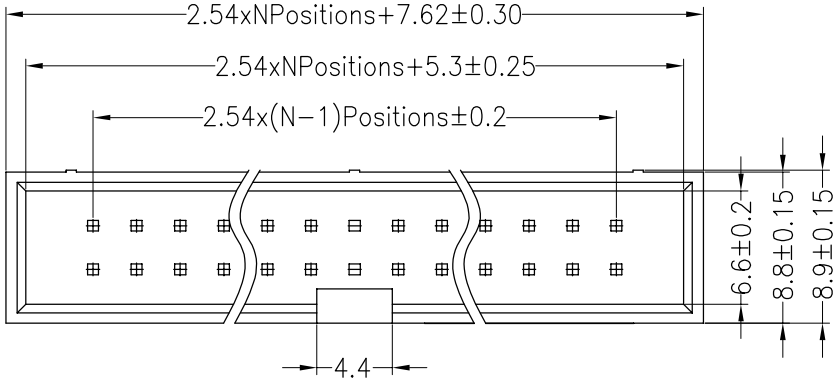
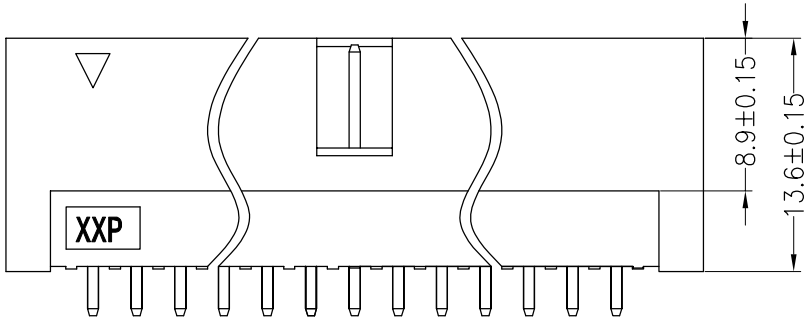
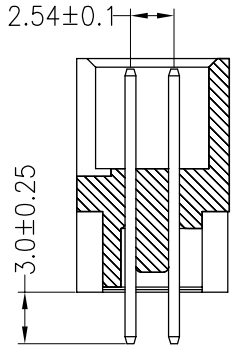
HSF RoHS

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PBT
Max.Processing Temp: 180°C for 30−60 seconds
(200°C for 10 seconds)



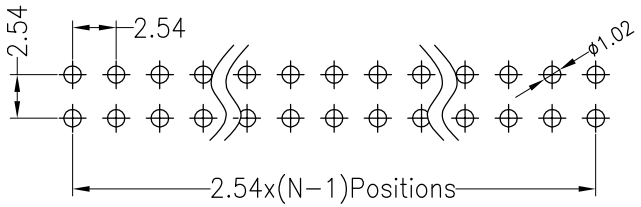




Ordering Information

3217 XX S XX X B K00 X 0X

No.of Pins	Contact Plating	Insulator Material	Packing	code stream
06−68P	G0:Gold Flash G1:1U" Gold G2:1.5U" Gold G3:2U" Gold G4:3U" Gold G5:5U" Gold G6:10U" Gold G7:15U" Gold S0:Gold Flash/Tin SN:Tin	Option A=BK−PBT B=BK−PA66 C=BK−PA6T D=BK−PA46 F=BK−LCP	0=PE Bag A=Tray T=Tube P=Tube+Cap	01~99



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2016.04.02	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW	Liu Miao	16.04.02
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	3217XXSXXXBK00X0X
TITLE:	2.54DC3 H13.6 NPIN